

DISCONTINUED



DMN4015LK3



40V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(on)}	I _D T _A = 25°C		
40V	15mΩ @ V _{GS} = 10V	20.8A		
400	20mΩ @ V _{GS} = 4.5V	18.0A		

Description and Applications

This new generation MOSFET has been designed to minimize the onstate resistance ($R_{DS(on)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Backlighting
- DC-DC Converters
- · Power management functions

Features and Benefits

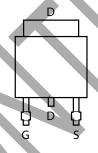
- · Low on-resistance
- Fast switching speed
- "Green" component and RoHS compliant (Note 1)

Mechanical Data

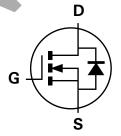
- Case: TO252-3L
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0 (Note 1)
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals Connections: See Diagram
- Terminals: Matte Tin Finish annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Marking Information: See Below
- Ordering Information: See Below
- Weight: 0.33 grams (approximate)



TOP VIEW



PIN OUT -TOP VIEW



Equivalent Circuit

Ordering Information (Note 1)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel	
DMN4015LK3-13	N4015L	13	16	2,500	

Note: 1. Diodes, Inc. defines "Green" products as those which are Eu RoHS compliant and contain no halogens or antimony compounds; further information about Diodes Inc.'s "Green" Policy can be found on our website. For packaging details, go to our website.

Marking Information



⊃¦¦ = Manufacturer's Marking
 N4015L = Product Type Marking Code
 YYWW = Date Code Marking
 YY = Last two digits of year (ex: 09 = 2009)
 WW = Week (01-52)





DMN4015LK3

Maximum Ratings @T_A = 25°C unless otherwise specified

Char	acteristic		Symbol Value		Unit	
Drain-Source voltage			V_{DSS}	40	V	
Gate-Source voltage			V_{GS}	±20	V	
		(Note 3)	ID	20.8		
Continuous Drain current	V _{GS} = 10V	T _A =70°C (Note 3)		16.6	Α	
		(Note 2)		13.5		
Pulsed Drain current V _{GS} = 10V		(Note 4)	I _{DM}	72.8	Α	
Continuous Source current (Body diode) (Note 3)		Is	13.2	Α		
Pulsed Source current (Body diode) (Note 4)		I _{SM}	72.8	A		

Thermal Characteristics @TA = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit	
	(Note 2)		4.36 34.8		
Power dissipation Linear derating factor	(Note 3)	P _D	10.3 82.4	W mW/°C	
	(Note 5)		2.19 17.5		
	(Note 2)		28.6		
Thermal Resistance, Junction to Ambient	(Note 3)	$R_{\theta JA}$	12.1	20044	
	(Note 5)		57.0	°C/W	
Thermal Resistance, Junction to Lead	(Note 6)	$R_{ heta}$ JL	0.85		
Operating and storage temperature range		T _J , T _{STG}	-55 to 150	°C	

Notes:

- 2. For a device surface mounted on 50mm x 50mm x 1.6mm, FR4 PCB with high coverage of single sided 2oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
- 3. Same as note 2, except the device is measured at $t \le 10$ sec.
- Same as note 2, except the device is measured at t≤ 10 sec.
 Same as note 2, except the device is pulsed with D = 0.02 and pulse width 300 µs. The pulse current is limited by the maximum junction temperature.
 For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.

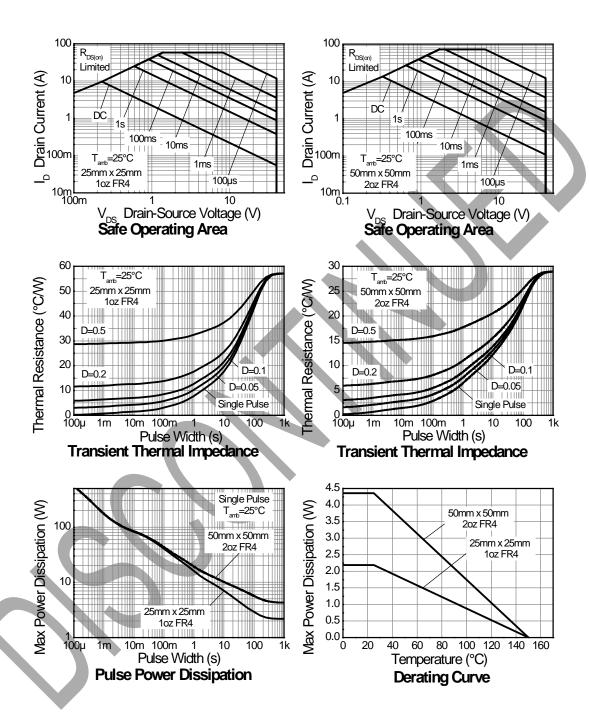
 6. Thermal resistance from junction to solder-point (at the end of the drain lead).





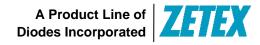


Thermal Characteristics









DMN4015LK3

Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic		Min	Тур	Max	Unit	Test Co	ondition
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage	BV _{DSS}	40	_	_	V	$I_D = 250 \mu A, V_{GS} = 0 V$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	0.5	μА	V _{DS} = 40V, V _{GS} =	0V
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	V _{GS} = ±20V, V _{DS} =	= 0V
ON CHARACTERISTICS							
Gate Threshold Voltage	V _{GS(th)}	1.0		3.0	٧	I _D = 250μA, V _{DS} = V _{GS}	
Static Drain Source On Begintenes (Note 7)	0			15		V _{GS} = 10V, I _D = 14	ŀA
Static Drain-Source On-Resistance (Note 7)	R _{DS (ON)}	_	_	20	m•	$V_{GS} = 4.5V, I_{D} = 1$	1A
Forward Transconductance (Notes 7 & 8)	9 _{fs}	_	35.3	_	S	V _{DS} = 15V, I _D = 12	A.
Diode Forward Voltage (Note 7)	V _{SD}	_	0.87	1.0	V	I _S = 14A, V _{GS} = 0\	/
Reverse recovery time (Note 8)	t _{rr}		141		ns	1 440 -11/-14 4/	2011
Reverse recovery charge (Note 8)	Q _{rr}	_	872	-	nC	I _S = 14A, di/dt= 10	JUΑ/μS
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	C _{iss}	_	2072	_	pF	-47	
Output Capacitance	Coss	_	338		pF	V_{DS} = 20V, V_{GS} = 0V f= 1MHz	
Reverse Transfer Capacitance	Crss	_	193	-	pF	1= 11VII 12	
Total Gate Charge	Qg		21		nC	V _{GS} = 4.5V	
Total Gate Charge	Qg	-	42	-	nC		V _{DS} = 20V
Gate-Source Charge	Q _{gs}	A	7.3		nC	V _{GS} = 10V	I _D = 14A
Gate-Drain Charge	Q _{gd}	—	10.7	_	nC		
Turn-On Delay Time (Note 9)	t _{D(on)}		7.8		ns		
Turn-On Rise Time (Note 9)	tr	_	18.5		ns	V _{DD} = 20V, V _{GS} = 10V	
Turn-Off Delay Time (Note 9)	t _{D(off)}	_	37.3	_	ns	$I_D= 14A, R_G \cong 6.0\Omega$	
Turn-Off Fall Time (Note 9)	t _f		14.9	_	ns		

Notes:

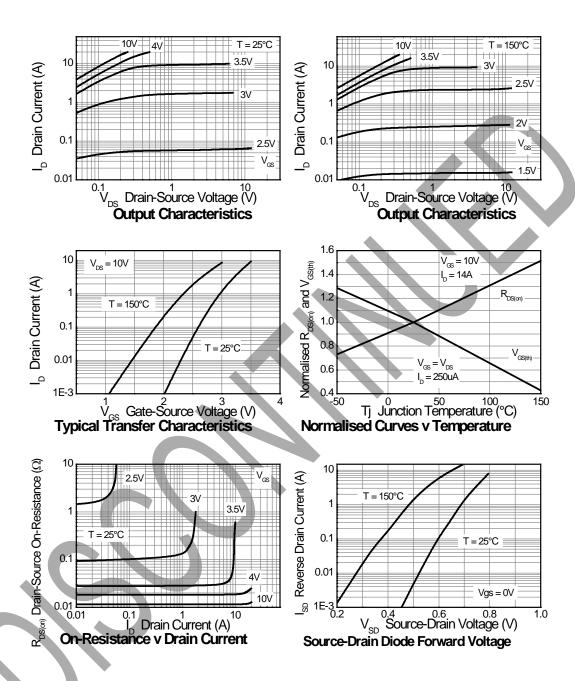
- Measured under pulsed conditions. Pulse width ≤ 300 µs; duty cycle ≤ 2%
 For design aid only, not subject to production testing.
 Switching characteristics are independent of operating junction temperatures.







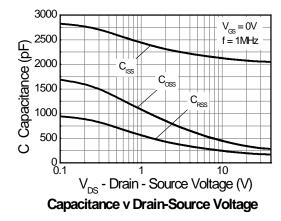
Typical Characteristics

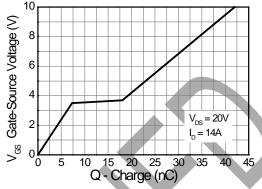






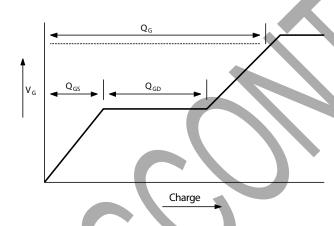
Typical Characteristics - continued

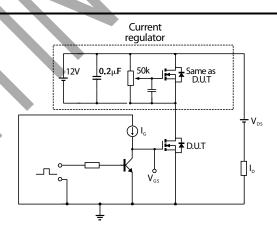




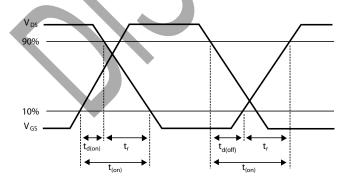
Gate-Source Voltage v Gate Charge

Test Circuits

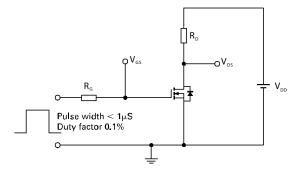




Basic gate charge waveform



Gate charge test circuit



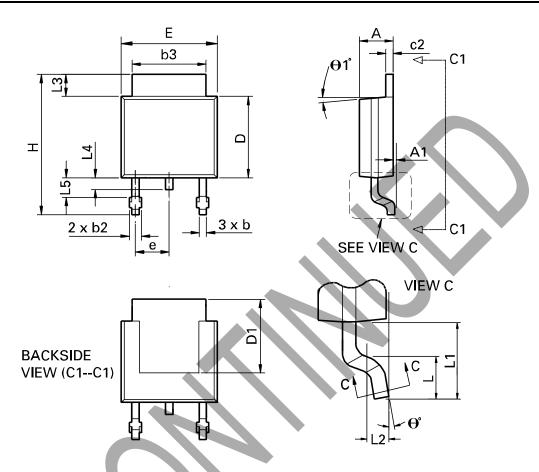
Switching time waveforms

Switching time test circuit





Package Outline Dimensions

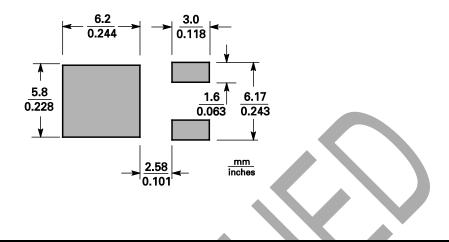


DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min	Max	Min	Max		Min	Max	Min	Max
Α	0.086	0.094	2.18	2.39	е	0.090 BSC		2.29 BSC	
A 1	-	0.005	-	0.127	Н	0.370	0.410	9.40	10.41
b	0.020	0.035	0.508	0.89	L	0.055	0.070	1.40	1.78
b2	0.030	0.045	0.762	1.14	L1	0.108 REF		2.74 REF	
b3	0.205	0.215	5.21	5.46	L2	0.020 BSC		0.508 BSC	
c	0.018	0.024	0.457	0.61	L3	0.035	0.065	0.89	1.65
c2	0.018	0.023	0.457	0.584	L4	0.025	0.040	0.635	1.016
D	0.213	0.245	5.41	6.22	L5	0.045	0.060	1.14	1.52
D1	0.205	-	5.21	-	•1°	0°	10°	0°	10°
E	0.250	0.265	6.35	6.73	• °	0°	15°	0°	15°
E1	0.170	-	4.32	-	-	-	-	-	-





Suggested Pad Layout



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